

Transistor

4V Drive Nch MOS FET

RSS095N05

●Structure

Silicon N-channel
MOS FET

●Features

- 1) Built-in G-S Protection Diode.
- 2) Small Surface Mount Package (SOP8).

●Applications

Power switching , DC / DC converter , Inverter

●Packaging dimensions

Package	Taping
Code	TB
Basic ordering unit(pieces)	2500

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-source voltage	V _{DSS}	45	V
Gate-source voltage	V _{GSS}	20	V
Drain current	Continuous	I _D	±9.5 A
	Pulsed	I _{DP} *1	±38 A
Source current (Body diode)	Continuous	I _S	1.6 A
	Pulsed	I _{SP} *1	38 A
Total power dissipation	P _D *2	2	W
Chanel temperature	T _{ch}	150	°C
Range of Storage temperature	T _{stg}	-55 to +150	°C

*1 PW≤10μs、Duty cycle≤1%

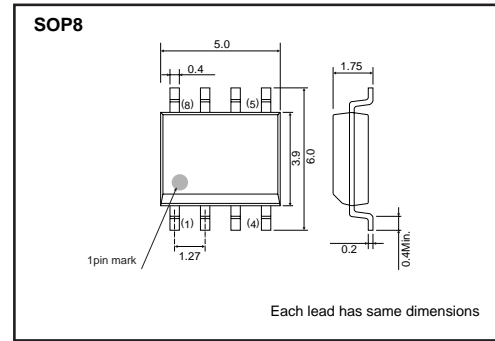
*2 Mounted on a ceramic board

●Thermal resistance

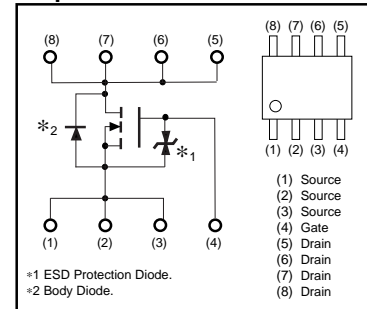
Parameter	Symbol	Limits	Unit
Chanel to ambient	R _{th(ch-a)} *	62.5	°C/W

* Mounted on a ceramic board

●External dimensions (Unit : mm)



●Equivalent circuit



* A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use a protection circuit when the fixed voltage are exceeded.

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●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	10	μA	$V_{GS}=20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	45	–	–	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	–	–	1	μA	$V_{DS}=45V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1.0	–	2.5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)}$ *	–	11	16	$m\Omega$	$I_D=9.5A, V_{GS}=10V$
		–	14	20	$m\Omega$	$I_D=9.5A, V_{GS}=4.5V$
		–	15	21	$m\Omega$	$I_D=9.5A, V_{GS}=4V$
Forward transfer admittance	$ Y_{fs} $ *	10.0	–	–	S	$V_{DS}=10V, I_D=9.5A$
Input capacitance	C_{iss}	–	1830	–	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	–	410	–	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	–	210	–	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}$ *	–	20	–	ns	$V_{DD}\doteq 25V$
Rise time	t_r *	–	35	–	ns	$I_D=5.0A$
Turn-off delay time	$t_{d(off)}$ *	–	78	–	ns	$V_{GS}=10V$
Fall time	t_f *	–	31	–	ns	$R_L=5\Omega$
Total gate charge	Q_g *	–	18.9	26.5	nC	$V_{DD}\doteq 25V, V_{GS}=5V$
Gate-source charge	Q_{gs} *	–	4.9	–	nC	$I_D=9.5A$
Gate-drain charge	Q_{gd} *	–	7.2	–	nC	$R_L=2.6\Omega, R_G=10\Omega$

*Pulsed

Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD} *	–	–	1.2	V	$I_S=9.5A, V_{GS}=0V$

*Pulsed

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●Electrical characteristic curves

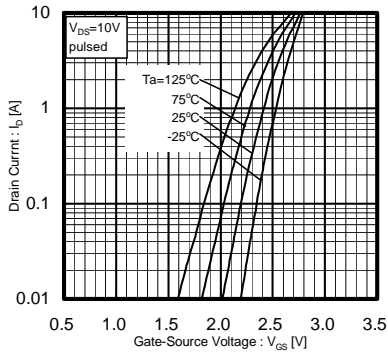


Fig.1 Typical Transfer Characteristics

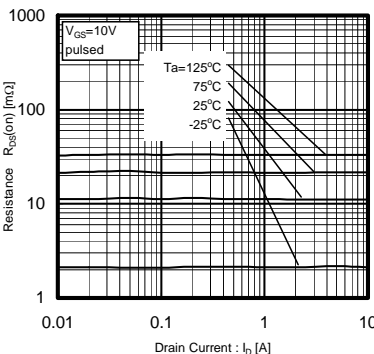


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

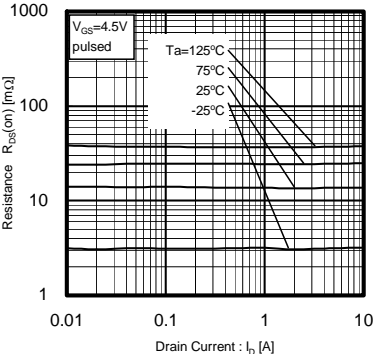


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)

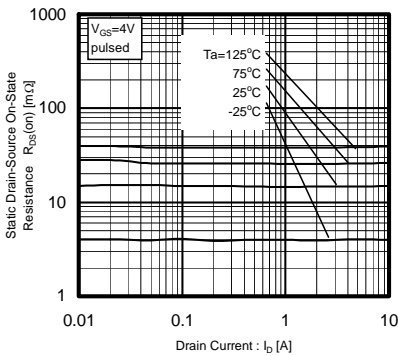


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (3)

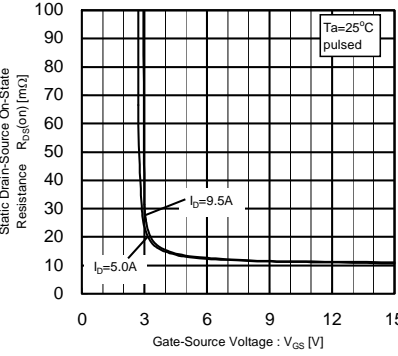


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

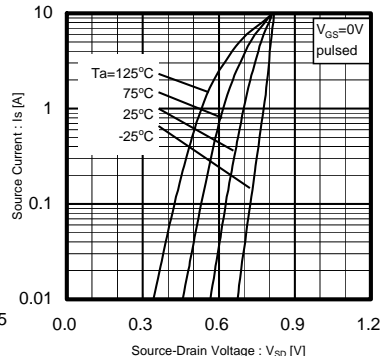


Fig.6 Source-Current vs. Source-Drain Voltage

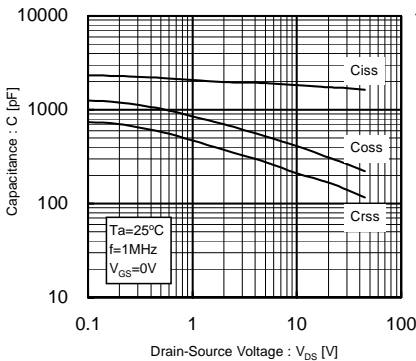


Fig.7 Typical capacitance vs. Source-Drain Voltage

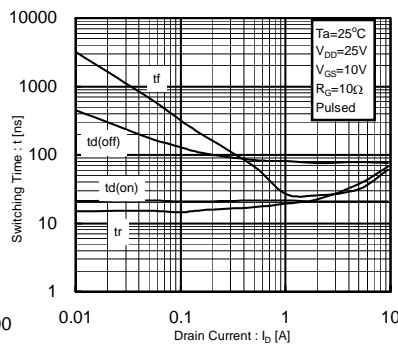


Fig.8 Switching Characteristics

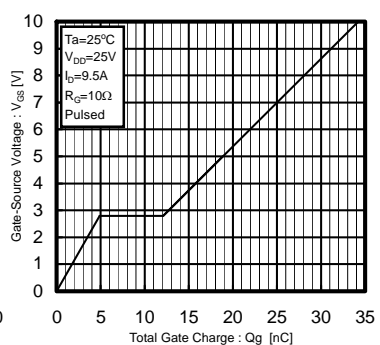


Fig.9 Dynamic Input Characteristics

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● Measurement circuits

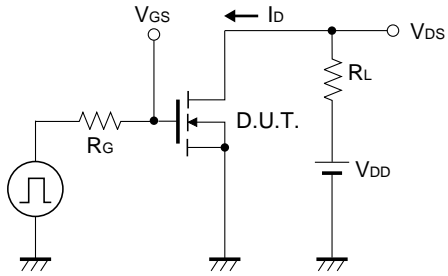


Fig.10 Switching Time Test Circuit

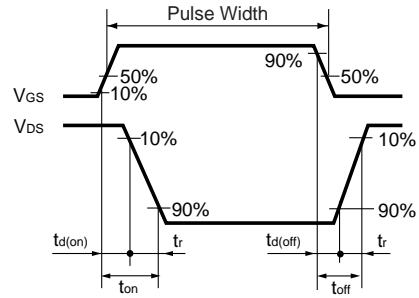


Fig.11 Switching Time Waveforms

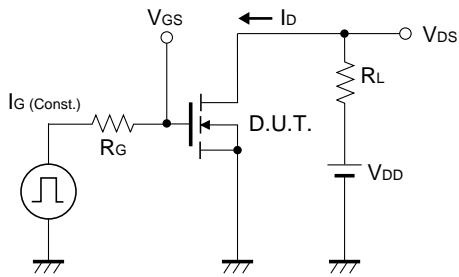


Fig.12 Gate Charge Test Circuit

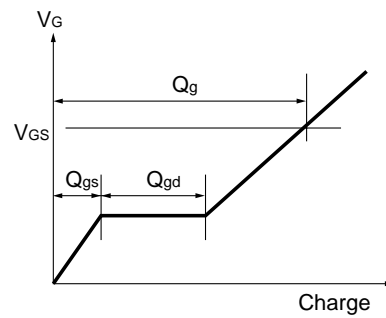


Fig.13 Gate Charge Waveform

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